MKT373M (Mini)

Vishay BCcomponents



DC Film Capacitors MKT Radial Potted Type

FEATURES

- 10 mm to 27.5 mm lead pitch
- Supplied loose in box taped on ammopack or reel



HALOGEN

FREE

• Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

APPLICATIONS

Blocking, coupling, and decoupling, bypass and energy reservoir, industrial, consumer, lighting.

QUICK REFERENCE DATA	
Capacitance range (E12 series)	0.01 µF to 10 µF
Capacitance tolerance	± 10 %, ± 5 %
Climatic testing class according to IEC 60068-1	55/105/56
Maximum application temperature	105 °C
Reference standards	IEC 60384-2
Dielectric	Polyester film
Electrodes	Metallized
Construction	Mono construction
Encapsulation	Flame retardant plastic case and epoxy resin UL-class 94 V-0
Leads	Tinned wire
Marking	C-value; tolerance; rated voltage; manufacturer's symbol; year and week of manufacture; manufacturer's type designation
Rated (DC) voltage	250 V, 400 V, 630 V
Rated (AC) voltage	63 V, 100 V, 160 V
Rated temperature	85 °C
Performance grade	Grade 1 (long life)

Note

For more detailed data and test requirements, contact <u>dc-film@vishay.com</u>



1 For technical questions, contact: <u>dc-film@vishay.com</u>

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COMPOSITION OF CATALOG NUMBER

TYPE A	AND PITCHES											MULTIP	
	10.0 mm							-				(nF) 3
373 M	15.0 mm					-	PACITANC umerically					10	4
0/0 10	22.5 mm					, u	uniericaliy)				100	5
	27.5 mm							F ires				1000	6
					_			Exar	npie: = 10 x 1	0 – 100	nF		Ţ
								104	- 10 X 1	0 - 100			
							5						
		R	FC2	З.	73	ХХ	YY	V	Μ	Ζ			
				5	10			I	111	2		PITCH	COL
		22	222 (*)	З.	73	ΧХ	YY	V	Μ	Ζ		(mm)	
		22	` /	5	/0	$\Lambda\Lambda$		I	111	2		10	D
		(*) Olo	d ordering nu	umber							_	15	F
		. ,	0									22.5	I
												27.5	K
									PRE	FERRI		PES	
TYPE	PACKAGI	NG	LEAD	CONF	IGURAT	ION							

ТҮРЕ	PACKAGING	LEAD CONFIGURATION	PREFERRED TYPES					
TIPE	PACKAGING	LEAD CONFIGURATION	C-TOL.	250 V	400 V	630 V		
	Loose in box	Lead length 4.0 + 1.0/- 0.5 mm	± 10 %	EE	FE	GE		
	LOOSE III DOX		±5%	EF	FF	GF		
373 M	Taped on reel ⁽¹⁾	H = 18.5 mm; P_0 = 12.7 mm; Reel diameter = 356 mm	± 10 %	EL	FL	GL		
373 101			± 5 %	EM	FM	GM		
	Ammopack ⁽¹⁾	H = 18.5 mm; P ₀ = 12.7 mm	± 10 %	EB	FB	GB		
			± 5 %	EC	FC	GC		

Note

⁽¹⁾ For detailed tape specifications refer to packaging information: <u>www.vishay.com/doc?28139</u>

SPECIFIC REFERENCE DATA							
DESCRIPTION	VALUE						
Tangent of loss angle:	at 1 kHz	at 10 kHz	at 100 kHz				
C ≤ 0.1 µF	≤ 75 x 10 ⁻⁴	≤ 130 x 10 ⁻⁴	≤ 250 x 10 ⁻⁴				
$0.1 \ \mu F < C \le 0.47 \ \mu F$	≤ 75 x 10 ⁻⁴	≤ 130 x 10 ⁻⁴	\leq 300 x 10 ⁻⁴				
$0.47 \ \mu F < C \le 1.0 \ \mu F$	≤ 75 x 10 ⁻⁴	≤ 130 x 10 ⁻⁴	-				
$1.0 \ \mu F < C \le 10 \ \mu F$	≤ 75 x 10 ⁻⁴	≤ 150 x 10 ⁻⁴	-				
C > 10 μF	≤ 75 x 10 ⁻⁴	-	-				
Rated voltage pulse slope (dU/dt) _R at	250 V _{DC}	400 V _{DC}	630 V _{DC}				
L _{max.} = 12.5 mm	20 V/µs	45 V/µs	137 V/µs				
L _{max.} = 17.5 mm	11 V/µs	20 V/µs	44 V/µs				
L _{max.} = 26.0 mm	7 V/µs	10 V/µs	17 V/µs				
L _{max.} = 30.0 mm	5 V/µs	8 V/µs	12 V/µs				
R between leads, for C \leq 0.33 μ F at 100 V; 1 min	> 30 000 MΩ	> 30 000 MΩ	-				
R between leads, for C \leq 0.33 μ F at 500 V; 1 min	-	-	> 30 000 MΩ				
RC between leads, for C > 0.33 µF at 100 V; 1 min	> 10 000 s	> 10 000 s	-				
RC between leads, for C > 0.33 µF at 500 V; 1 min	-	-	> 10 000 s				
R between interconnecting leads and casing, 100 V; 1 min		> 30 000 MΩ					
Withstanding (DC) voltage (cut off current 10 mA) ⁽¹⁾ ;	250 V _{DC}	400 V _{DC}	630 V _{DC}				
rise time \leq 1000 V/s:	400 V; 1 min	640 V; 1 min	1008 V; 1 min				
Withotonding (DC) voltage between loads and case for	250 V _{DC}	400 V _{DC}	630 V _{DC}				
Withstanding (DC) voltage between leads and case for	500 V; 1 min	800 V; 1 min	1260 V; 1 min				
Maximum application temperature	105 °C						

Note

⁽¹⁾ See "Voltage Proof Test for Metallized Film Capacitors": <u>www.vishay.com/doc?28169</u>



ELE	CTRI	CAL DATA AN	D OR	DERING IN	FORMAT	ION					
					CATALO	G NUMBER B		YYMZ AND	PACKAGIN	G	
		AP. DIMENSIONS IF) w x h x l (mm)		LOOSE IN BOX		REE	L (1)(2)	AMMO	PACK ⁽²⁾		
	045			l _t = 4.0 mm + 1.0 mm/		H = 18.5 mm;		H = 18.5 mm;		_	РІТСН
U _{RDC} (V)	CAΡ. (μF)		MASS (g) ⁽³⁾	- 0.5 C-TOL. =	mm C-TOL. =	$P_0 = 12$ C-TOL. =	2.7 mm C-TOL. =	P ₀ = 12.7 mm C-TOL. = C-TOL. =		C-	mm
.,	. ,			± 10 %	± 5 %	± 10 %	± 5 %	± 10 %	± 5 %	YYY	CODE MZ
				XX (SPQ)	XX (SPQ)	XX (SPQ)	XX (SPQ)	XX (SPQ)	XX (SPQ)		
			PITC	CH = 10.0 mn	n ± 0.40 mm;	d _t = 0.60 mm	± 0.06 mm (l	J _{RAC} = 63 V)			1
	0.10									104	MD
	0.12									124	MD
	0.15	4.0 x 10.0 x 12.5	0.65	EE	EF	EL	EM	EB	EC	154	MD
	0.18	4.0 X 10.0 X 12.5	0.65	(1000)	(1000)	(1400)	(1400)	(750)	(750)	184	MD
	0.22									224	MD
	0.27									274	MD
	0.33	5.0 x 11.0 x 12.5	0.87	EE	EF	EL	EM	EB	EC	334	MD
	0.39	5.0 × 11.0 × 12.5	0.07	(1000)	(1000)	(1100)	(1100)	(600)	(600)	394	MD
	0.47	6.0 x 12.0 x 12.5	1.15	EE	EF	EL	EM	EB	EC	474	MD
	0.56	0.0 × 12.0 × 12.3	1.10	(750)	(750)	(900)	(900)	(500)	(500)	564	MD
			PITC	CH = 15.0 mn	n ± 0.40 mm;	d _t = 0.60 mm	± 0.06 mm (l	J _{RAC} = 63 V)			1
	0.56	5.0 x 11.0 x 17.5	1.1	EE (1000)	EF (1000)	EL (1100)	EM (1100)	Not available		564	MF
	0.68	6.0 x 12.0 x 17.5	1.5	EE	EF	EL	EM	Not available		684	MF MF
	$\begin{array}{c c c c c c c c c c c c c c c c c c c $										
			PIIC	EE	EF		± 0.08 mm (0	$J_{RAC} = 03 V$			1
250	1.0	7.0 x 13.5 x 17.5	2.0	(1000)	(1000)	EL (800)	(800)	-			MF
	1.2	8.5 x 15.0 x 17.5	2.7	EE (1000)	EF (1000)	EL (650)	EM (650)	Not av	/ailable	125	MF
	1.5	10.0 × 16 5 - 17 5	0 ··· 10 F ··· 17 F 0 F	. ,	. ,	. ,	. ,			155	MF
	1.8	10.0 x 16.5 x 17.5	3.5	EE (500)	EF (500)	EL (600)	EM (600)		185	MF	
	0.0		PIIC	7H = 22.5 mn	h ± 0.40 mm;	d _t = 0.80 mm	± 0.08 mm (0	J _{RAC} = 63 V)		005	N AL
	2.2	9 E y 19 O y 06 O	4 E	EE	EF	EL	EM			225	MI
	2.7 3.3	8.5 x 18.0 x 26.0	4.5	(200)	(200)	(450)	(450)			275	MI
										335	MI
	3.9	10.0 × 10.5 × 26.0	57	EE	EF	EL	EM	Not av	/ailable	395	MI
	4.7 5.6	10.0 x 19.5 x 26.0	5.7	(200)	(200)	(350)	(350)			475	MI
	5.6 6.8									565 685	MI MI
	8.2	12.0 x 22.0 x 26.0	7.8	EE (150)	EF (150)	EL (300)	EM (300)			825	MI
	0.2		PITO	. ,		d _t = 0.80 mm	. ,	lava = 63 V)		020	IVII
				EE	EF	-, - 0.00 mm					
	6.8	13.0 x 23.0 x 31.0	10.4	(100)	(100)					685	MK
	8.2	15.0 x 25.0 x 31.5	12.8	EE	EF	Not av	/ailable	Not av	/ailable	825	MK
	10.0			(100)	(100)					106	MK
	15.0	18.0 x 28.0 x 31.5	18.4	EE (100)	EF (100)					156	MK

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ELE	LECTRICAL DATA AND ORDERING INFORMATION												
						G NUMBER B				G			
					IN BOX	REE	L (1)(2)		PACK ⁽²⁾	ļ			
	CAP.	DIMENSIONS w x h x l	MASS	l _t = 4.0 mm + 1.0 mm/ - 0.5 mm			.5 mm; 2.7 mm		.5 mm; 2.7 mm	C-	PITCH mm		
(V)	(μF)	(μF) (mm)	(g) ⁽³⁾	C-TOL. = ± 10 %	C-TOL. = ± 5 %	C-TOL. = ± 10 %	C-TOL. = ± 5 %	C-TOL. = ± 10 %	C-TOL. = ± 5 %	VALUE YYY	CODE MZ		
							XX (SPQ)	XX (SPQ)	XX (SPQ)	XX (SPQ)	XX (SPQ)	XX (SPQ)	
		PITCH = 10.0 mm \pm 0.40 mm; d _t = 0.60 mm \pm 0.06 mm (U _{RAC} = 100 V)											
	0.082									823	MD		
	0.10	4.0 x 10.0 x 12.5	0.65	FE	FF	FL	FM	FB	FC	104	MD		
	0.12	4.0 X 10.0 X 12.5	0.05	(1000)	(1000)	(1400)	(1400)	(750)	(750)	124	MD		
	0.15									154	MD		
	0.18									184	MD		
	0.22	5.0 x 11.0 x 12.5	0.87	FE (1000)	FF (1000)	FL (1100)	FM (1100)	FB (600)	FC (600)	224	MD		
	0.27			(1000)	(1000)	(1100)	(1100)	(000)	(000)	274	MD		
	0.33	6.0 x 12.0 x 12.5	1.15	FE (750)	FF (750)	FL (900)	FM (900)	FB (500)	FC (500)	334	MD		
			PITC	H = 15.0 mm	± 0.40 mm; 0	d _t = 0.60 mm	± 0.06 mm (U	_{BAC} = 100 V)	. ,		1		
	0.27									274	MF		
	0.33	5.0 x 11.0 x 17.5	1.1	FE	FF	FL	FM			334	MF		
	0.39			(1000)	(1000)	(1100)	(1100)	Not available		394	MF		
	0.47			FE	FF	FL	FM			474	MF		
	0.56	6.0 x 12.0 x 17.5	1.5	(1000)	(1000)	(900)	(900)			564	MF		
			PITC	H = 15.0 mm	± 0.40 mm; o	d _t = 0.80 mm		_{RAC} = 100 V)		1			
	0.68	7.0 x 13.5 x 17.5	2.0	FE (1000)	FF (1000)	FL (800)	FM (800)			684	MF		
400	0.82					-				824	MF		
400	1.0	8.5 x 15.0 x 17.5	2.7	FE (1000)	FF (1000)	FL (650)	FM (650)	Not av	vailable	105	MF		
	1.2			()	()	()	()			125	MF		
	1.5	10.0 x 16.5 x 17.5	3.5	FE (500)	FF (500)	FL (600)	FM (600)			155	MF		
			PITC	H = 22.5 mm	± 0.40 mm; o	d _t = 0.80 mm	± 0.08 mm (U	_{RAC} = 100 V)		•			
	1.0									105	MI		
	1.2	7.0 x 16.5 x 26.0	3.3	FE (200)	FF (200)	FL (450)	FM (450)			125	MI		
	1.5			(200)	(200)	(430)	(430)			155	МІ		
	1.8			FE	FF	FL	FM			185	MI		
	2.2	8.5 x 18.0 x 26.0	4.5	(200)	(200)	(450)	(450)	Not av	vailable	225	МІ		
	2.7			FE	FF	FL	FM	1		275	MI		
	3.3	10.0 x 19.5 x 26.0	5.7	(200)	(200)	(350)	(350)		335	MI			
	3.9	12.0 x 22.0 x 26.0	7.8	FE (150)	FF (150)	FL (300)	FM (300)			395	МІ		
			PITC	H = 27.5 mm	± 0.40 mm; o	d _t = 0.80 mm	± 0.08 mm (U	_{RAC} = 100 V)		•			
	2.7	9.0 x 19.0 x 31.5	5.5	FE (100)	FF (100)					275	MK		
	3.3	11.0 x 21.0 x 31.0	7.8	FE (100)	FF (100)	Not av	vailable	Not av	vailable	335	МК		
	3.9	13.0 x 23.0 x 31.0	10.4	FE (100)	FF (100)					395	МК		
	•			•						•			



		CAL DATA AN							DACKACIN	<u>_</u>	
				10005			BFC2 373 XXY			G	r
		CAP. μF) DIMENSIONS w x h x l (mm)		LOOSE			L (1)(2)			+	
	CAP.		MASS	l _t = 4.0 mm + 1.0 mm/ - 0.5 mm		H = 18.5 mm; P ₀ = 12.7 mm		$P_0 = 12$.5 mm; 2.7 mm	C-	PITCH mm
(V)	(μ-)		(g) ⁽³⁾	C-TOL. = ± 10 %	C-TOL. = ± 5 %	C-TOL. = ± 10 %	C-TOL. = ± 5 %	C-TOL. = ± 10 %	C-TOL. = ± 5 %	VALUE	CODE MZ
				XX (SPQ)	XX (SPQ)	XX (SPQ)	XX (SPQ)	XX (SPQ)	XX (SPQ)		
			PITC	H = 10.0 mm	± 0.40 mm; o	d _t = 0.60 mm	± 0.06 mm (U	_{RAC} = 160 V)			
	0.010									103	MD
	0.012									123	MD
	0.015									153	MD
	0.018									183	MD
	0.022	4.0	0.05	GE	GF	GL	GM	GB	GC	223	MD
	0.027	4.0 x 10.0 x 12.5	0.65	(1000)	(1000)	(1400)	(1400)	(750)	(750)	273	MD
	0.033									333	MD
	0.039									393	MD
	0.047									473	MD
	0.056									563	MD
	0.068			GE	GF	GL	GM	GB	GC	683	MD
	0.082	5.0 x 11.0 x 12.5	0.87	(1000)	(1000)	(1100)	(1100)	(600)	(600)	823	MD
	0.100	6.0 x 12.0 x 12.5	1.15	GE (750)	GF (750)	GL (900)	GM (900)	GB (500)	GC (500)	104	MD
	PITCH = 15.0 mm ± 0.40 mm; d _t = 0.60 mm ± 0.06 mm (U _{RAC} = 160 V)							-			
	0.082			05	05		014			823	MF
	0.100		1.1 GE (1000)	GF (1000)	GL (1100)	GM (1100)			104	MF	
	0.120			(1000)	(1000)	(1100)	(1100)	Not av	vailable	124	MF
	0.150	6.0 x 12.0 x 17.5	1.5	GE (1000)	GF (1000)	GL (900)	GM (900)	-		154	MF
	0.180		PITC	()	,	,	()			184	MF
630	PITCH = 15.0 mm ± 0.40 mm; dt = 0.80 mm ± 0.08 mm (U _{RAC} = 160 V)										
	0.22	7.0 x 13.5 x 17.5	2.0	(1000)	(1000)	(800)	(800)	-		224	MF
	0.27			GE	GF	GL	GM			274	MF
	0.33	8.5 x 15.0 x 17.5	2.7	(1000)	(1000)	(650)	(650)	Not av	vailable	334	MF
	0.39			· · ·	. ,	. ,	. ,			394	MF
	0.47	10.0 x 16.5 x 17.5	3.5	GE (500)	GF (500)	GL (600)	GM (600)			474	MF
			PITC	()	()	()	± 0.08 mm (U	$r_{\rm NAC} = 160 {\rm V}$			
	0.33				± 0.40 mm, (at = 0.00 mm	2 0.00 mm (0			334	MI
	0.39									394	MI
	0.00						<u>CM</u>			474	MI
	0.47	8.5 x 18.0 x 26.0	4.5	GE (200)	GF (200)	GL (450)	GM (450)			564	
	0.56			(200)	(200)	(400)	(400)			684	MI
								Not available			MI
	0.82						014			824	MI
	1.00	10.0 x 19.5 x 26.0	5.7	GE (200)	GF (200)	GL (350)	GM (350)			105	MI
	1.20	12.0 x 22.0 x 26.0	7.8	GE (150)	GF (150)	GL (300)	GM (300)			125	MI
			PITC			d _t = 0.80 mm	± 0.08 mm (U	RAC = 160 V)		•	•
	0.82	9.0 x 19.0 x 31.5	5.5	GE (100)	GF (100)		-			824	MK
	1.00					Not av	/ailable	Not av	vailable	105	МК
	1.20	11.0 x 21.0 x 31.0	7.8	GE (100)	GF (100)						
	1.20	L	l	(100)	(100)	ļ		I		125	MK

Notes

• SPQ = Standard Packing Quantity

(1) $H = in-tape height; P_0 = sprocket hole distance; for detailed specifications refer to Packaging Information.$

⁽²⁾ Reel diameter = 356 mm is available on request

⁽³⁾ Weight for short lead product only

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MOUNTING

Normal Use

The capacitors are designed for mounting on printed-circuit boards. The capacitors packed in bandoliers are designed for mounting in printed-circuit boards by means of automatic insertion machines.

For detailed tape specifications refer to type detail information: www.vishay.com/doc?28139

Specific Method of Mounting to Withstand Vibration and Shock

In order to withstand vibration and shock tests, it must be ensured that the underside of this product is in good contact with the printed-circuit board:

- For pitches \leq 15 mm capacitors shall be mechanically fixed by the leads
- For larger pitches the capacitors shall be mounted in the same way and the body clamped

Ratings and Characteristics Reference Conditions

Unless otherwise specified, all electrical values apply to an ambient temperature of 23 °C \pm 1 °C, an atmospheric pressure of 86 kPa to 106 kPa and a relative humidity of 50 % \pm 2 %.

For reference testing, a conditioning period shall be applied over 96 h \pm 4 h by heating the products in a circulating air oven at the rated temperature and a relative humidity not exceeding 20 %.

Space Requirements on Printed-Circuit Board

The maximum space for length (I_{max}), width (w_{max}), and height (h_{max}) of film capacitors to take in account on the printed-circuit board is shown in the drawings:

- For products with pitch \leq 15 mm, $\Delta w = \Delta I = 0.3$ mm and $\Delta h = 0.1$ mm
- For products with 15 mm < pitch \leq 27.5 mm, $\Delta w = \Delta I = 0.5$ mm and $\Delta h = 0.1$ mm

Eccentricity defined as in drawing. The maximum eccentricity is smaller than or equal to the lead diameter of the product concerned.



SOLDERING CONDITIONS

For general soldering conditions and wave soldering profile, we refer to the application note: **"Soldering Guidelines for Film Capacitors"**: <u>www.vishay.com/doc?28171</u>

Storage Temperature

 $T_{sta} = -25$ °C to +35 °C with RH maximum 75 % without condensation



MKT373M (Mini)

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CHARACTERISTICS



Capacitance as a function of frequency



Impedance as a function of frequency



Max. RMS voltage and AC current (sinewave)



Capacitance as a function of ambient temperature



Max. DC and AC voltage as a function of temperature



Max. RMS voltage and AC current (sinewave)





Max. RMS voltage and AC current (sinewave)



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Max. RMS voltage and AC current (sinewave)



Max. RMS voltage and AC current (sinewave)

Maximum RMS Current (Sinewave) as a Function of Frequency

The maximum RMS current is defined by $I_{AC} = \omega \times C \times U_{AC}$.

U_{AC} is the maximum AC voltage depending on the ambient temperature in the curves "Max. RMS voltage and AC current as a function of frequency".

For technical questions, contact: <u>dc-film@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>







Tangent of loss angle as a function of frequency (typical curve)







Insulation resistance as a function of the ambient temperature (typical curve)

HEAT CONDUCTIVITY (G) AS A FUNCTION OF (ORIGINAL) PITCH AND CAPACITOR BODY THICKNESS IN mW/°C

W _{max} .	HEAT CONDUCTIVITY (mW/°C)							
(mm)	PITCH 10 mm	PITCH 15 mm	PITCH 22.5 mm	PITCH 27.5 mm				
4.0	6.0	-	-	-				
4.5	-	-	-	-				
5.0	7.5	10	-	-				
6.0	9.0	11	19	-				
7.0	-	12	21	-				
8.5	-	16	25	-				
10.0	-	18	28	-				
11.0	-	-	-	36				
12.0	-	-	34	-				
13.0	-	-	-	42				
15.0	-	-	-	48				
18.0	-	-	-	57				

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9 For technical questions, contact: <u>dc-film@vishay.com</u> Document Number: 28157

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POWER DISSIPATION AND MAXIMUM COMPONENT TEMPERATURE RISE

The power dissipation must be limited in order not to exceed the maximum allowed component temperature rise as a function of the free ambient temperature.

The power dissipation can be calculated according type detail specification "HQN-384-01/101: Technical Information Film Capacitors", <u>www.vishay.com/doc?28147</u>.

The component temperature rise (Δ T) can be measured (see section "Measuring the component temperature" for more details) or calculated by Δ T = P/G:

- ΔT = component temperature rise (°C)
- P = power dissipation of the component (mW)
- G = heat conductivity of the component (mW/°C)

MEASURING THE COMPONENT TEMPERATURE

A thermocouple must be attached to the capacitor body as in:



The temperature is measured in unloaded (T_{amb}) and maximum loaded condition (T_{C}).

The temperature rise is given by $\Delta T = T_C - T_{amb}$.

To avoid radiation or convection, the capacitor should be tested in a wind-free box.

APPLICATION NOTE AND LIMITING CONDITIONS

These capacitors are not suitable for mains applications as across-the-line capacitors.

For capacitors connected in parallel, normally the proof voltage and possibly the rated voltage must be reduced. For information depending of the capacitance value and the number of parallel connections contact: <u>dc-film@vishay.com</u>

To select the capacitor for a certain application, the following conditions must be checked:

- 1. The peak voltage (U_P) shall not be greater than the rated DC voltage (U_{RDC})
- 2. The peak-to-peak voltage (U_{P-P}) shall not be greater than $2\sqrt{2} \times U_{RAC}$ to avoid the ionization inception level
- 3. The voltage peak slope (dU/dt) shall not exceed the rated voltage pulse slope in an RC-circuit at rated voltage and without ringing. If the pulse voltage is lower than the rated DC voltage, the rated voltage pulse slope may be multiplied by U_{RDC} and divided by the applied voltage.

For all other pulses following equation must be fulfilled:

$$2 x \int_{0}^{T} \left(\frac{dU}{dt}\right)^{2} x dt < U_{RDC} x \left(\frac{dU}{dt}\right)_{rated}$$

T is the pulse duration.

The rated voltage pulse slope is valid for ambient temperatures up to 85 °C. For higher temperatures a derating factor of 3 % per K shall be applied.

- 4. The maximum component surface temperature rise must be lower than the limits (see figure Max. Allowed Component Temperature Rise).
- 5. Since in circuits used at voltages over 280 V peak-to-peak the risk for an intrinsically active flammability after a capacitor breakdown (short circuit) increases, it is recommended that the power to the component is limited to 100 times the values mentioned in the table: "Heat Conductivity"
- 6. When using these capacitors as across-the-line capacitor in the input filter for mains applications or as series connected with an impedance to the mains the applicant must guarantee that the following conditions are fulfilled in any case (spikes and surge voltages from the mains included).

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VOLTAGE CONDITIONS FOR 6 ABOVE					
ALLOWED VOLTAGES	T _{amb} ≤ 85 °C	85 °C < T _{amb} ≤ 105 °C			
Maximum continuous RMS voltage	U _{RAC}	0.8 x U _{RAC}			
Maximum temperature RMS-overvoltage (< 24 h)	1.25 x U _{RAC}	1.0 x U _{RAC}			
Maximum peak voltage (V _{O-P}) (< 2 s)	1.6 x U _{RDC}	1.3 x U _{RDC}			

INSPECTION REQUIREMENTS

General Notes

Sub-clause numbers of tests and performance requirements refer to the "Sectional Specification, Publication IEC 60384-2 and Specific Reference Data".

GROUP C INSPECTION REQU SUB-CLAUSE NUMBER AND TEST	CONDITIONS	PERFORMANCE REQUIREMENTS
	CONDITIONS	PERFORMANCE REQUIREMENTS
SUB-GROUP C1A PART OF SAMPLE OF SUB-GROUP C1		
4.1 Dimensions (detail)		As specified in chapter "General Data" of this specification
4.3.1 Initial measurements	Capacitance at 1 kHz Tangent of loss angle: for C \leq 470 nF at 100 kHz or for C > 470 nF at 10 kHz	
4.3 Robustness of terminations	Tensile and bending	No visible damage
4.4 Resistance to soldering heat	Method: 1A Solder bath: 280 °C ± 5 °C Duration: 10 s	
4.14 Component solvent resistance	Isopropylalcohol at room temperature Method: 2 Immersion time: 5 min ± 0.5 min Recovery time: min. 1 h, max. 2 h	
4.4.2 Final measurements	Visual examination	No visible damage Legible marking
	Capacitance	$ \Delta C/C \le 2$ % of the value measured initially
	Tangent of loss angle	$\begin{array}{l} \mbox{Increase of tan δ:} \\ \leq 0.005 \mbox{ for: } C \leq 100 \mbox{ nF or } \\ \leq 0.010 \mbox{ for: } 100 \mbox{ nF < C} \leq 220 \mbox{ nF or } \\ \leq 0.015 \mbox{ for: } 220 \mbox{ nF < C} \leq 470 \mbox{ nF and } \\ \leq 0.003 \mbox{ for: } C > 470 \mbox{ nF } \\ \mbox{ Compared to values measured in 4.3.1} \end{array}$
SUB-GROUP C1B PART OF SAMPLE OF SUB-GROUP C1		
4.6.1 Initial measurements	Capacitance at 1 kHz Tangent of loss angle: for C \leq 470 nF at 100 kHz or for C $>$ 470 nF at 10 kHz	
4.6 Rapid change of temperature	θA = lower category temperature θB = upper category temperature 5 cycles Duration t = 30 min	
	Visual examination	No visible damage



	UP C INSPECTION REQUI LAUSE NUMBER AND TEST	CONDITIONS	PERFORMANCE REQUIREMENTS		
SUB-G	ROUP C1B PART OF SAMPLE B-GROUP C1				
4.7	Vibration	Mounting: see section "Mounting" of this specification Procedure B4 Frequency range: 10 Hz to 55 Hz Amplitude: 0.75 mm or Acceleration 98 m/s ² (whichever is less severe) Total duration 6 h			
4.7.2	Final inspection	Visual examination	No visible damage		
4.9	Shock	Mounting: see section "Mounting" of this specification Pulse shape: half sine Acceleration: 490 m/s ² Duration of pulse: 11 ms			
4.9.3	Final measurements	Visual examination	No visible damage		
		Capacitance	$ \Delta C/C \le 5$ % of the value measured in 4.6.1		
		Tangent of loss angle	Increase of tan δ : ≤ 0.005 for: C ≤ 100 nF or ≤ 0.010 for: 100 nF < C ≤ 220 nF or ≤ 0.015 for: 220 nF < C ≤ 470 nF and ≤ 0.003 for: C > 470 nF Compared to values measured in 4.6.1		
		Insulation resistance	As specified in section "Specific Reference Data" of this specification		
OF SP	ROUP C1 COMBINED SAMPLE ECIMENS OF SUB-GROUPS ND C1B				
4.10	Climatic sequence				
4.10.2	Dry heat	Temperature: upper category temperature Duration: 16 h			
4.10.3	Damp heat cyclic Test Db, first cycle				
4.10.4	Cold	Temperature: lower category temperature Duration: 2 h			
4.10.6	Damp heat cyclic Test Db, remaining cycles				
4.10.6.	2 Final measurements	Visual examination	No visible damage Legible marking		
		Capacitance	$ \Delta C/C \leq 5$ % of the value measured in 4.4.2 or 4.9.3		
		Tangent of loss angle	Increase of tan δ : ≤ 0.007 for: $C \leq 100$ nF or ≤ 0.010 for: 100 nF < $C \leq 220$ nF or ≤ 0.015 for: 220 nF < $C \leq 470$ nF and ≤ 0.005 for: $C > 470$ nF Compared to values measured in 4.3.1 or 4.6.1		
		Insulation resistance	≥ 50 % of values specified in section "Specifi Reference Data" of this specification		

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GROUP C INSPECTION REQUIREMENTS							
SUB-CLAUSE NUMBER AND TEST	CONDITIONS	PERFORMANCE REQUIREMENTS					
SUB-GROUP C2							
4.11 Damp heat steady state	56 days, 40 °C, 90 % to 95 % RH						
4.11.1 Initial measurements	Capacitance at 1 kHz Tangent of loss angle at 1 kHz						
4.11.3 Final measurements	Visual examination	No visible damage Legible marking					
	Capacitance	$\left \Delta C/C\right \leq 5$ % of the value measured in 4.11.1.					
	Tangent of loss angle	Increase of tan $\delta \leq$ 0.005 Compared to values measured in 4.11.1					
	Insulation resistance	\geq 50 % of values specified in section "Specific Reference Data" of this specification					
SUB-GROUP C3							
4.12 Endurance	Duration: 2000 h 1.25 x U _{RDC} at 85 °C 1.0 x U _{RDC} at 105 °C						
4.12.1 Initial measurements	Capacitance at 1 kHz Tangent of loss angle: for C \leq 470 nF at 100 kHz or for C $>$ 470 nF at 10 kHz						
4.12.5 Final measurements	Visual examination	No visible damage Legible marking					
	Capacitance	$ \Delta C/C \le 5$ % compared to values measured in 4.12.1					
	Tangent of loss angle	$\begin{array}{l} \mbox{Increase of tan δ:} \\ \le 0.005 \mbox{ for: } C \le 100 \mbox{ nF or } \\ \le 0.010 \mbox{ for: } 100 \mbox{ nF } < C \le 220 \mbox{ nF or } \\ \le 0.015 \mbox{ for: } 220 \mbox{ nF } < C \le 470 \mbox{ nF and } \\ \le 0.003 \mbox{ for: } C > 470 \mbox{ nF } \\ \mbox{ Compared to values measured in } 4.12.1 \end{array}$					
	Insulation resistance	\geq 50 % of values specified in section "Specific Reference Data" of this specification					
SUB-GROUP C4							
4.13 Charge and discharge	10 000 cycles Charged to U _{RDC} Discharge resistance: $R = \frac{U_R}{C \times 2.5 \times (dU/dt)_R}$						
4.13.1 Initial measurements	Capacitance at 1 kHz Tangent of loss angle: for C \leq 470 nF at 100 kHz or for C $>$ 470 nF at 10 kHz						
4.13.3 Final measurements	Capacitance	$\left \Delta C/C \right \leq 3$ % compared to values measured in 4.13.1					
	Tangent of loss angle	$\begin{array}{l} \mbox{Increase of } tan \; \delta; \\ \leq 0.005 \; for; \; C \leq 100 \; nF \; or \\ \leq 0.010 \; for; \; 100 \; nF < C \leq 220 \; nF \; or \\ \leq 0.015 \; for; \; 220 \; nF < C \leq 470 \; nF \; and \\ \leq 0.003 \; for; \; C > 470 \; nF \\ \mbox{Compared to values measured in } 4.13.1 \end{array}$					
	Insulation resistance	\geq 50 % of values specified in section "Specific Reference Data" of this specification					

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